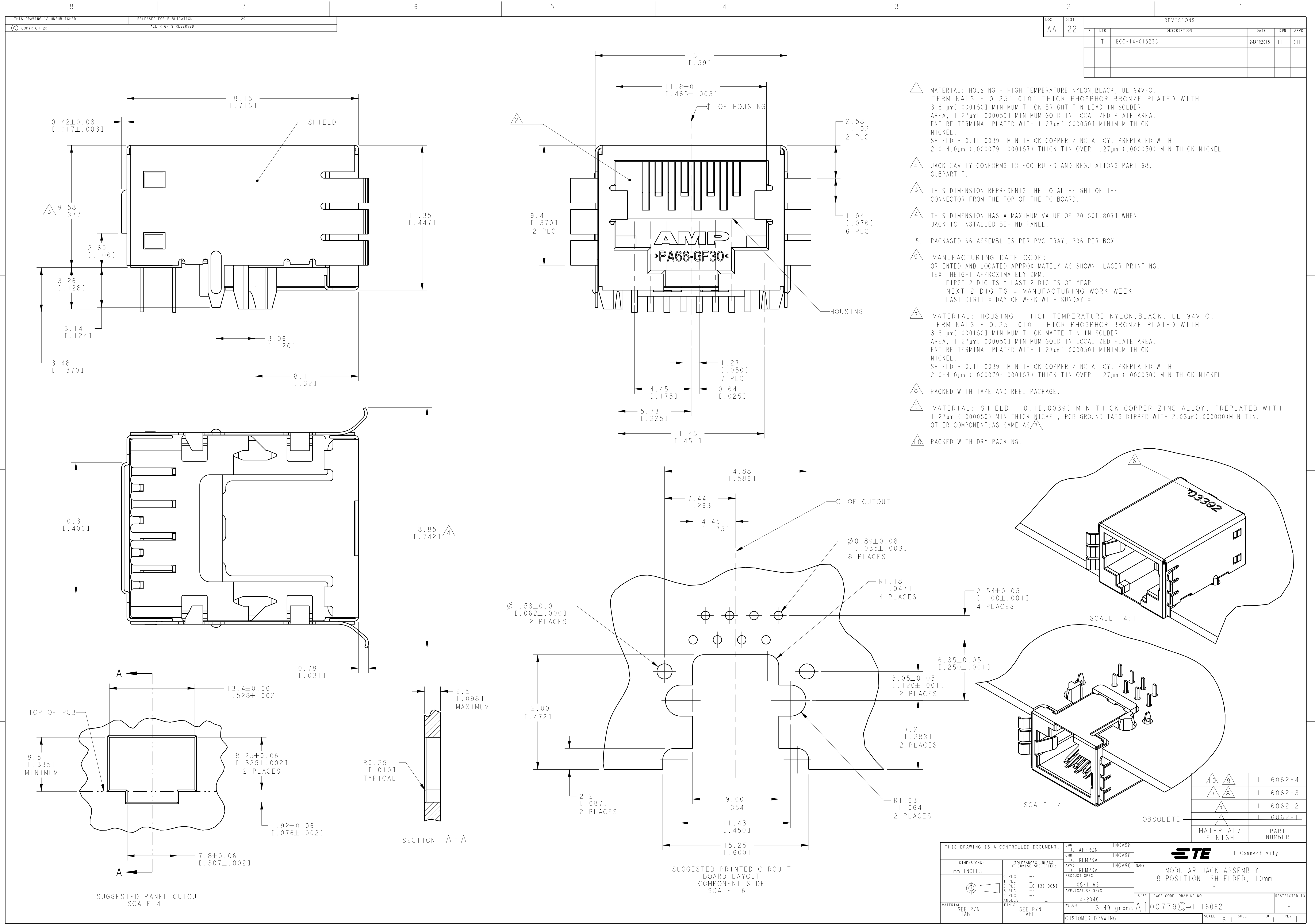
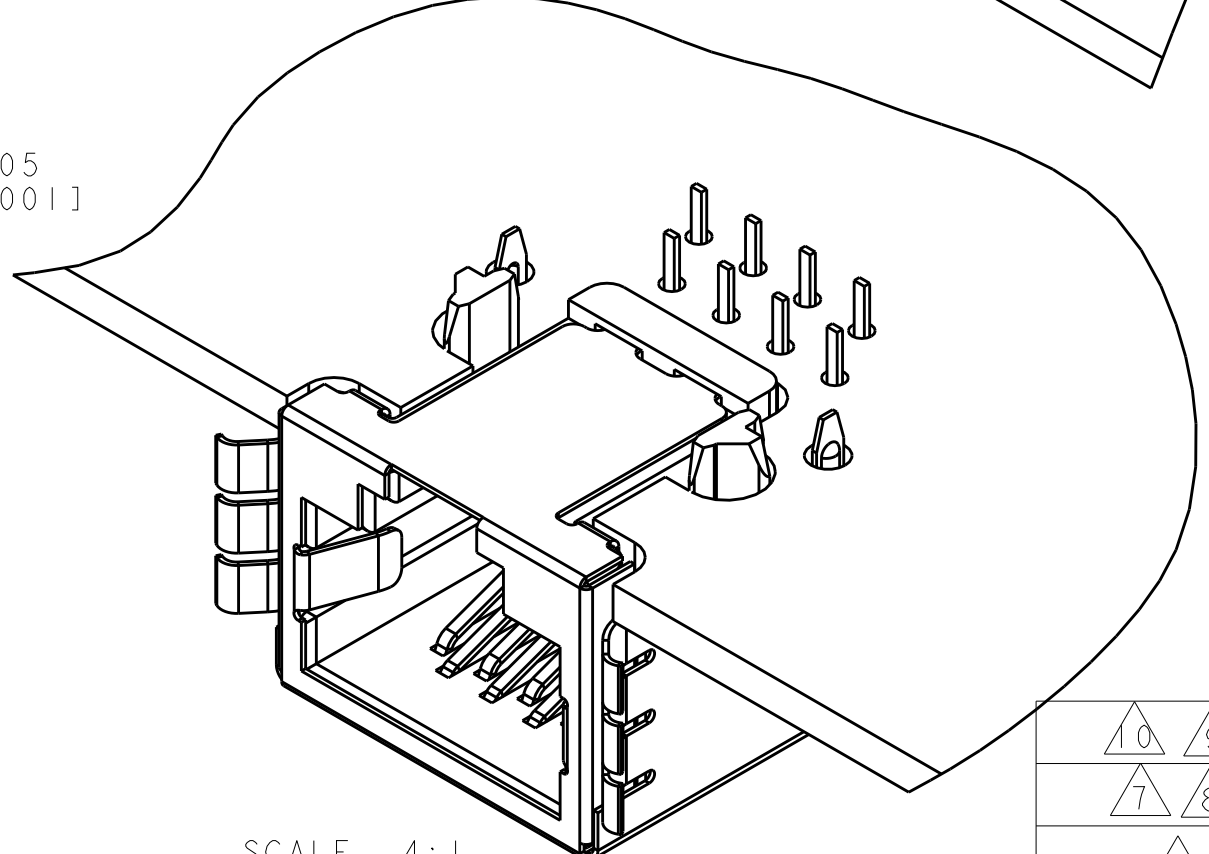
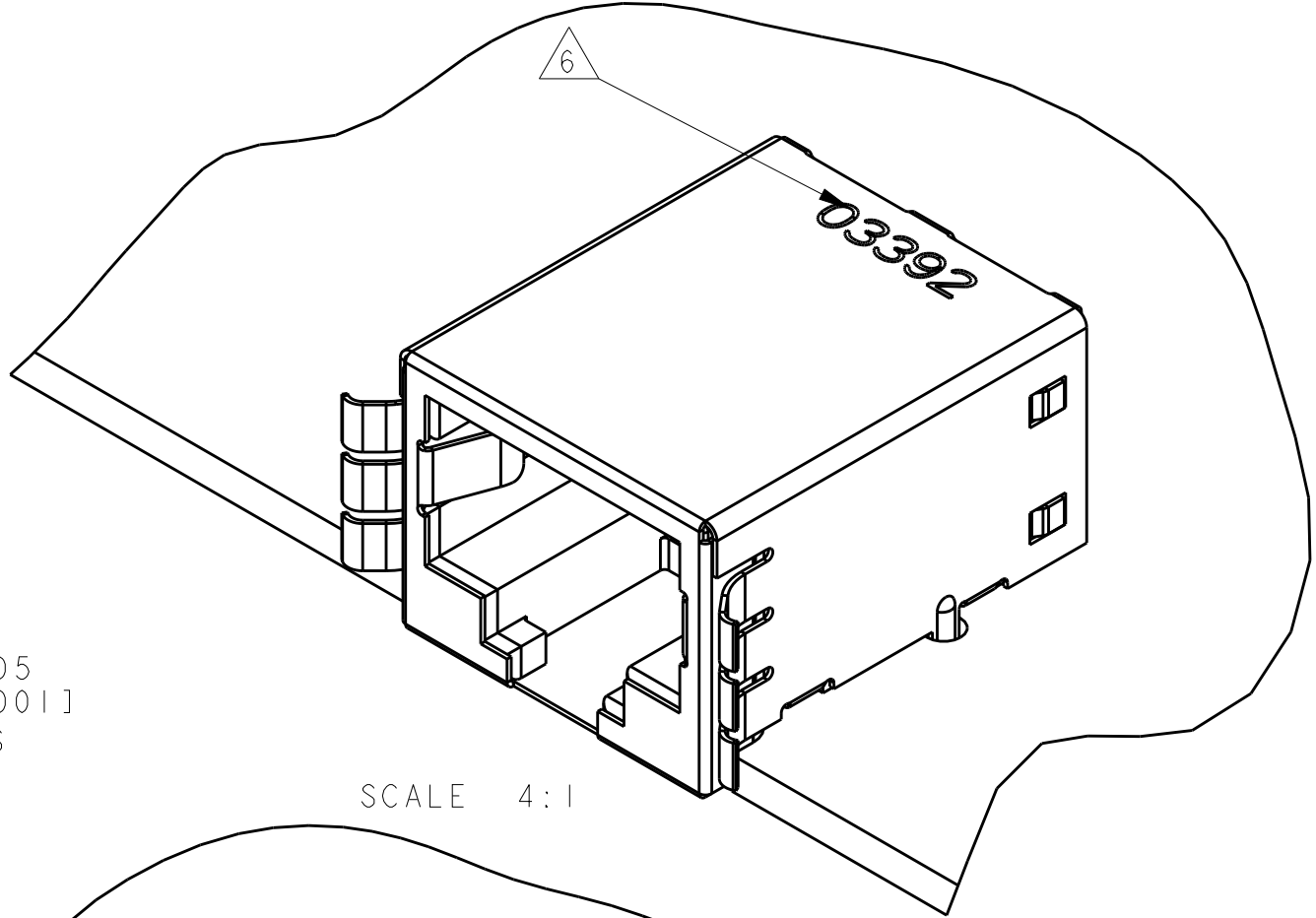




LOC	DIST	REVISIONS					
		P	LYR	DESCRIPTION	DATE	DWN	APVD
AA	22		T	ECO-14-015233	24APR2015	LL	SH

- 1 MATERIAL: HOUSING - HIGH TEMPERATURE NYLON,BLACK, UL 94V-0, TERMINALS - 0.25[.010] THICK PHOSPHOR BRONZE PLATED WITH 3.81µm[.000150] MINIMUM THICK BRIGHT TIN-LEAD IN SOLDER AREA, 1.27µm[.000050] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH 1.27µm[.000050] MINIMUM THICK NICKEL. SHIELD - 0.1[.0039] MIN THICK COPPER ZINC ALLOY, PREPLATED WITH 2.0-4.0µm (.000079-.000157) THICK TIN OVER 1.27µm (.000050) MIN THICK NICKEL.
- 2 JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
- 3 THIS DIMENSION REPRESENTS THE TOTAL HEIGHT OF THE CONNECTOR FROM THE TOP OF THE PC BOARD.
- 4 THIS DIMENSION HAS A MAXIMUM VALUE OF 20.50[.807] WHEN JACK IS INSTALLED BEHIND PANEL.
5. PACKAGED 66 ASSEMBLIES PER PVC TRAY, 396 PER BOX.
- 6 MANUFACTURING DATE CODE:
ORIENTED AND LOCATED APPROXIMATELY AS SHOWN. LASER PRINTING.
TEXT HEIGHT APPROXIMATELY 2MM.
FIRST 2 DIGITS = LAST 2 DIGITS OF YEAR
NEXT 2 DIGITS = MANUFACTURING WORK WEEK
LAST DIGIT = DAY OF WEEK WITH SUNDAY = 1
- 7 MATERIAL: HOUSING - HIGH TEMPERATURE NYLON,BLACK, UL 94V-0, TERMINALS - 0.25[.010] THICK PHOSPHOR BRONZE PLATED WITH 3.81µm[.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA, 1.27µm[.000050] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH 1.27µm[.000050] MINIMUM THICK NICKEL. SHIELD - 0.1[.0039] MIN THICK COPPER ZINC ALLOY, PREPLATED WITH 2.0-4.0µm (.000079-.000157) THICK TIN OVER 1.27µm (.000050) MIN THICK NICKEL.
- 8 PACKED WITH TAPE AND REEL PACKAGE.
- 9 MATERIAL: SHIELD - 0.1[.0039] MIN THICK COPPER ZINC ALLOY, PREPLATED WITH 1.27µm (.000050) MIN THICK NICKEL, PCB GROUND TABS DIPPED WITH 2.03µm(.000080)MIN TIN. OTHER COMPONENT:AS SAME AS 7
10. PACKED WITH DRY PACKING.



10	9	1116062-4
7	8	1116062-3
7		1116062-2
		1116062-1
MATERIAL / FINISH		PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN J. AHERON 11NOV98	 TE Connectivity	
DIMENSIONS: mm[INCHES]		CHK D. KEMPKA 11NOV98	NAME	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD D. KEMPKA 11NOV98	MODULAR JACK ASSEMBLY, 8 POSITION, SHIELDED, 10mm	